



Datasheet

Model No.: APXMDE-Xxx170208

APXMDE-Xxx170714





General features



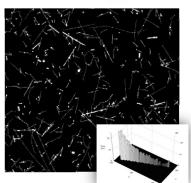


Illustration of single particle sensitivity of Timepix device. The tracks of different particles of radiation background (mostly muons and few protons) were recorded in 5 minutes on board of airplane. No noise (clean zero) is seen in dark regions. Inset shows the time profile along one muon track. Inset shows the time profile along one muon track.

ADVAPIX modules were designed with special emphasis to performance and versatility which is often required in a scientific experimental work. The fast modules with Si or CdTe pixel detectors Timepix can be used in different configurations such as stack of several layers or tiling to cover larger area or combination of both. Each module contains single Timepix device with fast parallel readout up to per second independent of frame occupancy. A separate USB 3.0 communication channel for each device assures fast read-out of the whole modular system. All modules in the system can be operated synchronously or triggered independently. The sensor type and thickness is of customer's choice.

The **ADVAPIX** can be used in a variety of applications such as fast radiography (X-rays, neutrons, ions), spectroscopic imaging (each pixel records the energy spectrum), particle tracking, time-of-flight imaging, multilayer Compton camera (thin top sensor, thick bottom sensor) and many other. The sensors can be adapted for neutron imaging by deposition of converter layers¹. The spatial resolution in some applications (slow neutrons) can reach units of microns or even sub-micrometric level (ions).

Main Features

| • | Readout chip type | TimePIX |
|---|----------------------------|-----------------------------------|
| • | Pixel size | 55 x 55 μm* |
| • | Sensor resolution | 256 x 256 pixels |
| • | Dynamic range in one frame | 11 810² |
| • | Time resolution | 20 ns |
| • | Sensor material | 100, 300, 500 μm Si, 1000 μm CdTe |
| • | Power | External or via second USB 3.0 |
| • | Interface | USB 3.0 (Super-Speed) |
| • | Maximum readout speed | 1700 fps |
| • | Dimensions | 125 x 79 x 25.5 mm |
| • | Weight | 503 g |

² A final picture can be created as sum of individual images. The dynamic range is limited only by the measurement time.



^{* 55} x 110 μm at the edges and 110 x 110 μm at the corners

¹Convertors based on 6LiF or 10B4C for slow neutrons (efficiency up to 4%) or PE for fast neutrons.



Device parameters

Operating conditions

| Symbol | Parameter | Value | Units | Comment |
|--------|---------------------------|-------|-------|-----------------|
| TA | Ambient Temperature Range | 0-50 | °C | |
| Φ | Humidity | <80 | % | Not condensing |
| | Altitude* | <2000 | m | Above sea level |
| IP | IP rating | IP40 | | With cover |

Warning: Disconnect the device from power during pumping down or venting the vacuum chamber!

Electrical Specification

 $T_A = 25$ °C, USB voltage $V_{CC} = 4.8V$

| Symbol | Parameter | Min | Тур | Max | Units | Comment |
|-------------------|---------------------------|------|-----|------|-------|------------------------------|
| Vcc | Supply Voltage | 4.0 | 5.0 | 5.5 | V | |
| Icc | Supply Current | | | | | |
| Icc1 | Chip active | | 800 | 1500 | mA | |
| P1 | Power Dissipation | | | 7.5 | W | |
| I/O Conn. Inpu | it CMOS 0-2.5 (pin 4,6) | | | | | |
| V _{INL} | Voltage Low | 0 | | 0.9 | V | |
| V _{INH} | Voltage High | 1.6 | | 2.5 | V | |
| I/O Conn. Out | put CMOS 0-2.5 (pin 3,5) | | | | | |
| Voutl | Voltage Low | 0 | | 0.45 | V | |
| Vouth | Voltage High | 2.05 | | 2.5 | V | |
| I/O Conn. Inpu | it CMOS 0-3.3V (pin 8,10) | | | | | |
| V _{INL} | Voltage Low | 0 | | 1.15 | V | |
| V _{INH} | Voltage High | 2.15 | | 3.3 | mV | |
| I/O Conn. +5V | (pin 2) | | | | | |
| I _{MAX} | Maximum current | 0 | | 0.5 | А | |
| V _{+5V} | Pin Voltage | | 4.5 | | V | Vcc - 0.5V |
| Bias Voltage So | ource for Sensor Diode | | | | | |
| V _{BIAS} | Bias Voltage | 0 | | ±450 | V | Polarity is sensor dependent |

Performance characteristics of Timepix

| Symbol | Parameter | Min | Тур | Max | Units | Comment |
|-------------------|--------------------|-----|-----|------|-------|--------------------|
| F _{READ} | Read-out frequency | | | 1700 | MHz | with USB 3.0 cable |
| T _{READ} | Frame Readout Time | | 588 | | μs | with USB 3.0 cable |
| dT | Time resolution | 20 | 100 | | ns | |

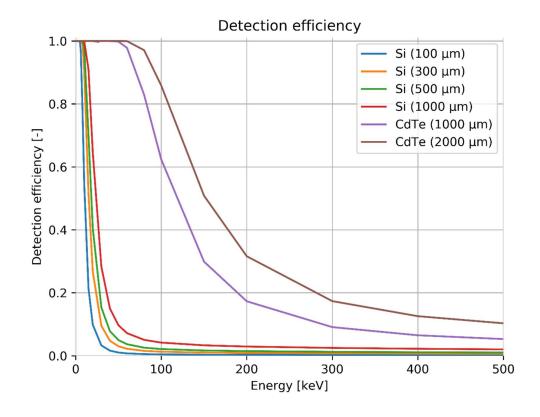




Sensor parameters

 $T_A = 25$ °C

| Symbol | Parameter | | Si | | CdTe | Units | Comment |
|--------|---|-------------|----|-------------|------|--------------------|---------|
| | Thickness | 100 300 500 | | 1000 | μm | | |
| σ | Energy resolution of energy discrimination threshold (σ @ 23 keV) | 0.5 1.1 keV | | | | | |
| σ | Energy resolution of energy discrimination threshold (σ @ 60 keV) | 0.6 1.5 keV | | | | | |
| σ | Energy resolution in full spectral mode (σ @ 23 keV) | 0.7 | | 3.0 | keV | | |
| σ | Energy resolution in full spectral mode (σ @ 60 keV) | 1.0 | | 3.6 | keV | | |
| | Typical detectable energy range for X-rays4 | 5 to 60 | | 5 to 500 | keV | See chart below | |
| | Pixel size | 55 | | 55 | μm | | |



Modes of readout chip operation

| Туре | Mode | Precision | Description |
|-------------|-------|-------------|---|
| Frame | Event | 13bit/frame | 1 output image: Number of Events per pixel |
| (reading | ToT | 13bit/frame | 1 output image: Sum of all Energies deposited in given pixel(Time Over Threshold) |
| all pixels) | ToA | 13bit/frame | 1 output image: Time of arrival of first event in given pixel |





Vacuum Operation

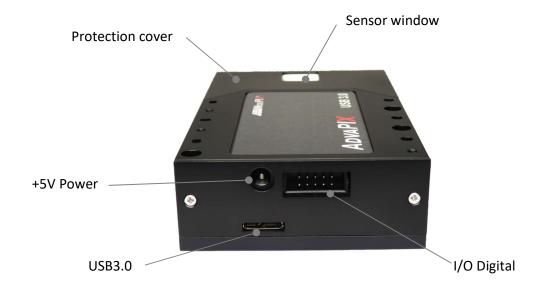
Advacam detectors can be vacuum compatible on request. Operate only with air pressure lower than 10⁻³Pa. Intended for dust free indoor use.

Make sure to disconnect the device from power during pumping down or venting the vacuum chamber!

External Cooling

Temperature stabilization is strongly recommended for consistent results. Attaching a Peltier cooling or cooling plate at the back of the detector should serve the purpose. The temperature should be set to 22°C.

Device description



+5VDC connector

Main power supply (via standard 5.5/2.1mm barrel connector). Connect after plugging USB connector.

USB 3.0 connector

USB type micro B, Standard USB 3.0 Super-Speed.

I/O Digital connector

Signals on I/O Digital connector are used for synchronization purposes. For details see Synchronization guide for TPX. Input pins are **NOT** +5V compatible. Pin 2 (+5V) may be used for power of external circuitry. It is taken directly from +5VDC connector, protected by schottky diode (0.5A max)



| Pin | Signal | Signal logic | Pin | Signal | Signal logic |
|-----|-------------|--------------|-----|-------------|--------------|
| 1 | GND | Power Ground | 2 | +5V | Power Output |
| 3 | Ready Out | CMOS 0-2.5V | 4 | Ready In | CMOS 0-2.5V |
| 5 | Trigger Out | CMOS 0-2.5V | 6 | Trigger In | CMOS 0-2.5V |
| 7 | Reserved | - | 8 | Ready Out | CMOS 0-3.3V |
| 9 | Reserved | - | 10 | Trigger Out | CMOS 0-3.3V |

Certificates

ADVAPIX has been tested by certification authority (Electrotechnical testing institute EZÚ) according to following standards:

| Standard number | Name |
|-----------------|---|
| EN 61010-1:2010 | Safety Requirements For Electrical Equipment For Measurement, Control, And Laboratory Use |
| EN 61326-1:13 | Electrical Equipment For Measurement, Control And Laboratory Use - EMC Requirements |

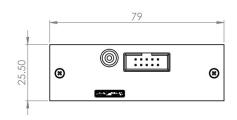


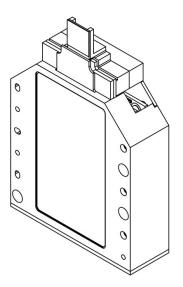


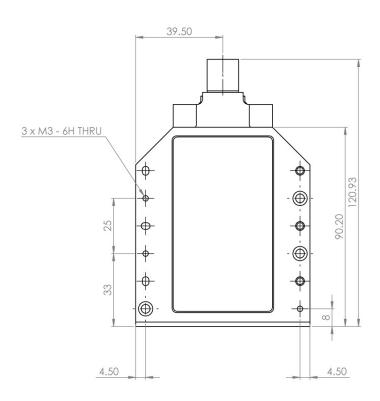
Mechanical dimensions

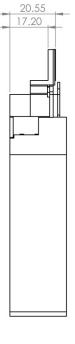
Without protection cover

Do not operate without protection cover!









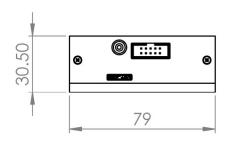
All dimensions are in mm.

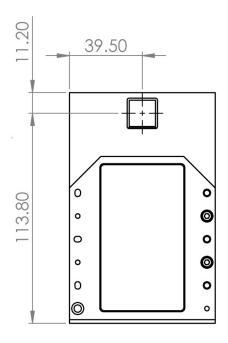
Extreme care must be taken when removing protecting cover and handling the **ADVAPIX** without the protecting cover. Warranty does not apply to mechanical damage of the sensor and wirebonds.

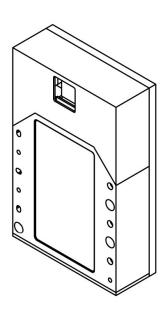


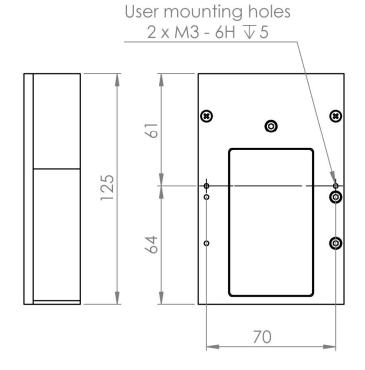


With protection cover







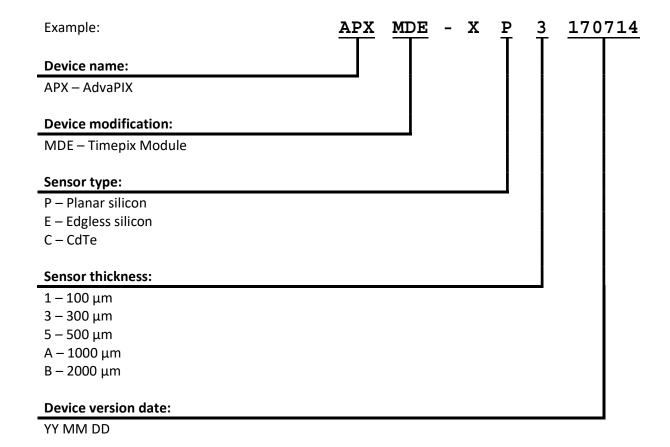


All dimensions are in mm.





Model Number Codes



Release history

| Date | Changes | | | |
|----------|---|--|--|--|
| 17/11/02 | Model number codes added, new datasheet version | | | |
| 18/08/13 | Synchronization connector corrected pinout and voltage levels | | | |
| 18/11/22 | Temperature, and warning updated | | | |
| 19/08/30 | EMC certificate numbers added | | | |
| 22/06/06 | Vacuum compatibility; sensor parameters | | | |
| | | | | |





Warning

Do not touch sensor surface!

Instructions for safe use

To avoid malfunction or damage to your **ADVAPIX** please observe the following:

- Do not expose to water or moisture.
- Do not disassemble. Wire-bonding connection may be irreversibly damaged.
- Do not insert any object into the sensor window.
- Extreme care must be taken when removing the protecting cover or handling the ADVAPIX without the
 protecting cover. Warranty does not apply to mechanical damage of the sensor and wirebonds
- The protection provided by this product may be impaired if it is used in a manner not described in this document

Disposal:



Do not dispose these instruments as unsorted municipal waste. Please use separate collection facility to contact the supplier from which the instrument was purchased. Please make sure discarded electrical waste is properly recycled to reduce environment impact

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